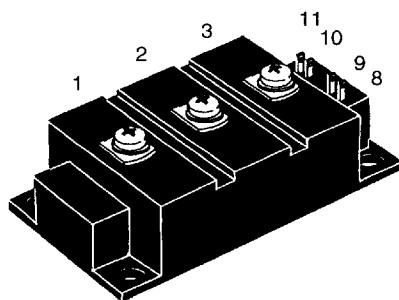
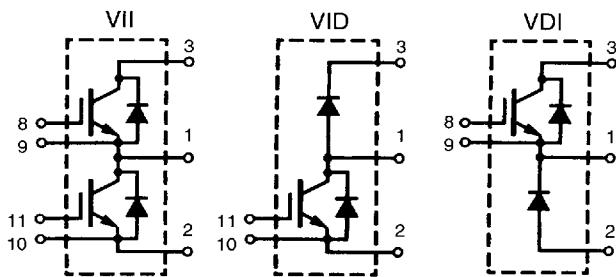


IGBT Modules

Half-Bridge and Chopper Configurations

VII 150-12S4 $I_{C(DC)} = 150 \text{ A}$
VID 150-12S4 $V_{CES} = 1200 \text{ V}$
VDI 150-12S4 $V_{CE(sat)} = 3.7 \text{ V}$

High Short Circuit SOA Capability



VID150 has no pin 8 + 9
VDI150 has no pin 10 + 11

Symbol	Test Conditions	Maximum Ratings		
V_{CES}	$T_J = 25^\circ\text{C} \text{ to } 150^\circ\text{C}$	1200		V
V_{CGR}	$T_J = 25^\circ\text{C} \text{ to } 150^\circ\text{C}; R_{GE} = 1 \text{ M}\Omega$	1200		V
V_{GES}	Continuous	± 20		V
V_{GEM}	Transient	± 30		V
I_{C25}	$T_c = 25^\circ\text{C}$	150		A
I_{C80}	$T_c = 80^\circ\text{C}$	138		A
I_{CM}	$T_c = 25^\circ\text{C}, t_p = 1 \text{ ms}$	300		A
t_{sc} (SCSOA)	$V_{GE} = 15 \text{ V}, V_{CE} = 0.6 \cdot V_{CES}, T_J = 125^\circ\text{C}$ $R_G = 4.7 \Omega$, non repetitive	10		μs
RBSOA	$V_{GE} = 15 \text{ V}, T_J = 125^\circ\text{C}, R_G = 4.7 \Omega$ Clamped inductive load, $L = 100 \mu\text{H}$	$I_{CM} = 300$ @ $0.8 V_{CES}$		A
P_{tot}	$T_c = 25^\circ\text{C}$	950		W
T_J		-40 ... +150		$^\circ\text{C}$
T_{Smax}		110		$^\circ\text{C}$
T_{sig}		-40 ... +125		$^\circ\text{C}$
V_{ISOL}	50/60 Hz, RMS $t = 1 \text{ min}$	3000		V~
	$I_{ISOL} \leq 1 \text{ mA} \quad t = 1 \text{ s}$	3600		V~
	Insulating material: Al_2O_3			
M_d	Mounting torque (M6)	2.25 - 2.75	Nm	
		20 - 25	lb.in.	
	Terminal connection torque (M5)	2.50 - 3.70	Nm	
		22 - 33	lb.in.	
d_s	Creepage distance on surface	10	mm	
d_a	Strike distance through air	9.6	mm	
a	Max. allowable acceleration	50	m/s^2	
Weight	Typical, including screws	0.25	kg	
		8.85	oz.	

Data according to a single IGBT/FRED unless otherwise stated.
IXYS reserves the right to change limits, test conditions and dimensions.

Features

- International standard package
- Package with DCB ceramic base plate
- Isolation voltage 3600 V~
- MOS-input (voltage controlled)
- Low saturation voltage
- High short circuit capability
- No latch-up
- Ultra fast free wheeling diode
- Low conduction and commutation losses
- Pulse frequency up to 20 kHz

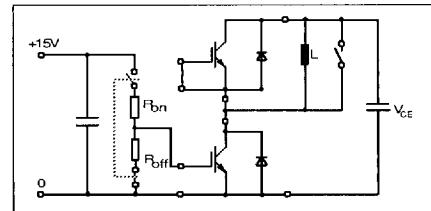
Applications

- AC motor speed control
- DC servo and robot drives
- Uninterruptible power systems (UPS)
- Switch-mode and resonant-mode power supplies
- Induction heating
- DC choppers

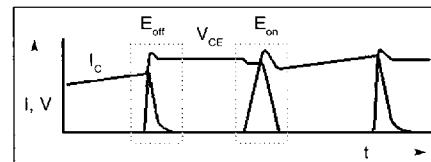
Advantages

- Space and weight savings
- Simple mounting
- Reduced protection circuits
- High $V_{GE(th)}$ for good noise immunity

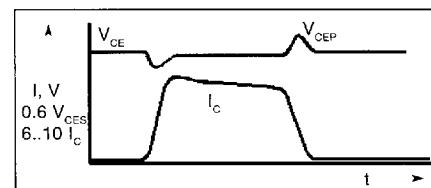
Symbol	Test Conditions	Characteristic Values ($T_J = 25^\circ\text{C}$, unless otherwise specified)		
		min.	typ.	max.
$V_{(\text{BR})\text{CES}}$	$I_C = 15 \text{ mA}, V_{GE} = 0 \text{ V}$	1200		V
$V_{GE(\text{th})}$	$I_C = 50 \text{ mA}, V_{CE} = V_{GE}$	5		8 V
I_{CES}	$V_{CE} = V_{\text{CES}}$ $V_{CE} = 0.8 \cdot V_{\text{CES}}$	$T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$		15 mA 45 mA
I_{GES}	$V_{CE} = 0 \text{ V}, V_{GE} = \pm 20 \text{ V}$			$\pm 500 \text{ nA}$
$V_{CE(\text{sat})}$	$I_C = 150 \text{ A}, V_{GE} = 15 \text{ V}$	3.7	4.0	V
C_{ies}	$V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 1 \text{ MHz}$	22.5	nF	
C_{oes}		2.5	nF	
C_{res}		0.45	nF	
$t_{d(on)}$	Inductive load, $T_J = 125^\circ\text{C}$	300	ns	
t_{rv}		200	ns	
$t_{d(off)}$		350	ns	
t_{ff}		700	ns	
E_{on}		20	24	mJ
E_{off}		23	29	mJ
R_{thJC}	for calculation of P_{tot} with heat transfer paste		0.13 K/W	
R_{thJS}			0.19 K/W	



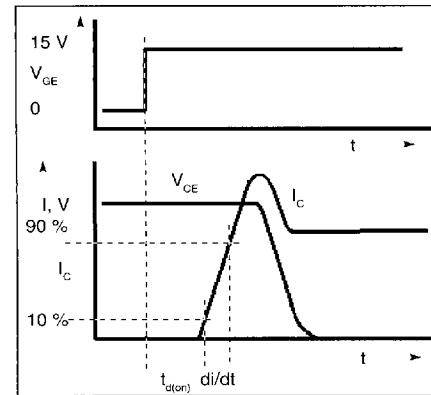
Test circuit for $E_{\text{on}}, E_{\text{off}}$, SCSOA and RBSOA
 $R_{\text{on}} = 1.2 \Omega$
 $L = 100 \mu\text{H}$
 $R_{\text{off}} = 4.7 \Omega$ for RBSOA, E_{off}



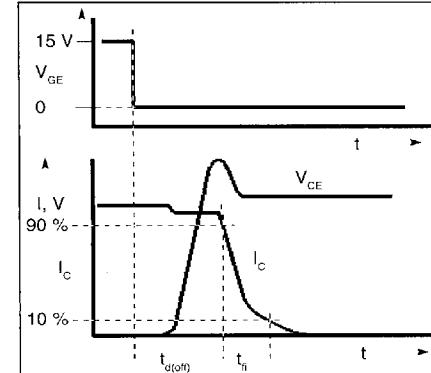
Typical V/I waveforms for inductive load



SCSOA conditions $V_{CE} = 0.6 V_{\text{CES}}$,
 $V_{CEP} < V_{\text{CES}}$, $T_J = 125^\circ\text{C}$



Turn-on waveforms E_{on}



Turn-off waveforms E_{off} RBSOA

Reverse Diode (FRED)

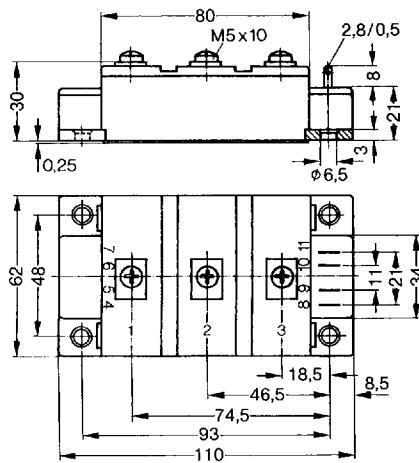
Characteristic Values

($T_J = 25^\circ\text{C}$, unless otherwise specified)

min. typ. max.

V_F	$I_F = 150 \text{ A}, V_{GE} = 0 \text{ V}$	1.8	1.9	V
I_F	$T_C = 25^\circ\text{C}$ $T_C = 80^\circ\text{C}$		150 A 141 A	
I_{RM}	$I_F = 150 \text{ A}, V_{GE} = 0 \text{ V}, -di_F/dt = 1200 \text{ A}/\mu\text{s}$	140	165	A
t_{rr}	$T_J = 125^\circ\text{C}, V_R = 600 \text{ V}$	200		ns
R_{thJC}	with heat transfer paste		0.31 K/W	
R_{thJS}			0.50 K/W	

Dimensions in mm (1 mm = 0.0394")



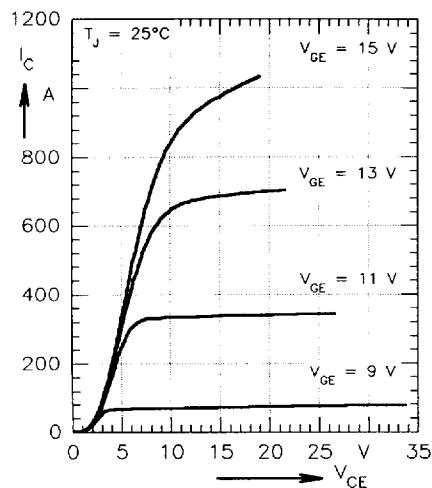


Fig. 1 Typ. output characteristics

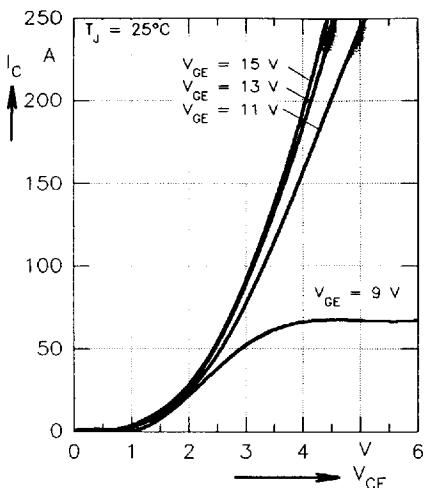


Fig. 2 Typ. output characteristics

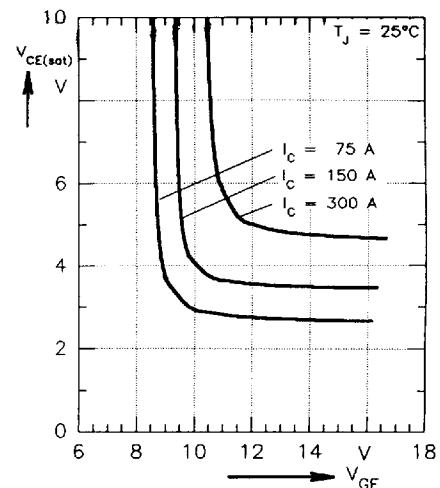


Fig. 3 Typ. on-state characteristics

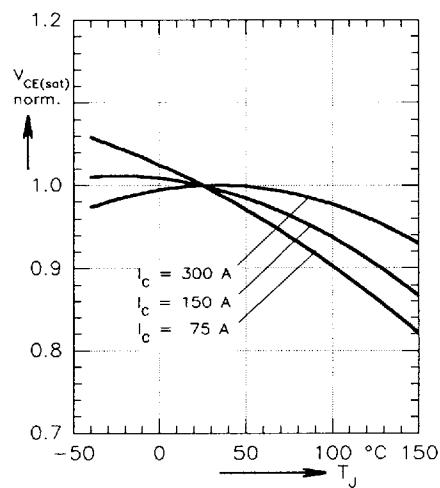


Fig. 4 Typ. temperature dependence of normalized $V_{CE(sat)}$

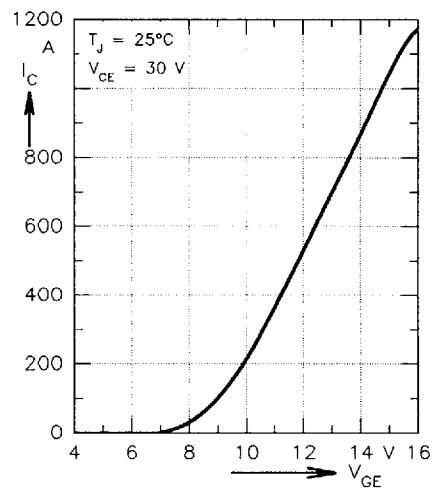


Fig. 5 Typ. transfer characteristics

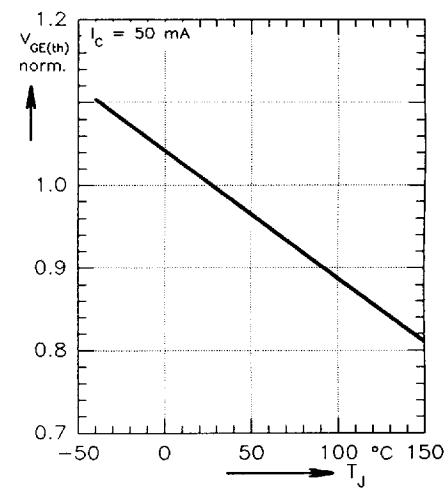


Fig. 6 Temperature dependence of normalized $V_{GE(th)}$

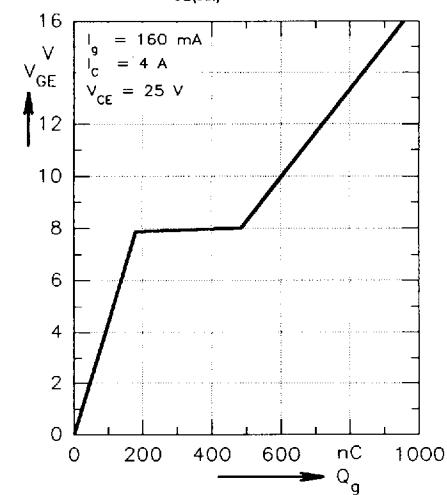


Fig. 7 Typ. turn-on gate charge characteristics

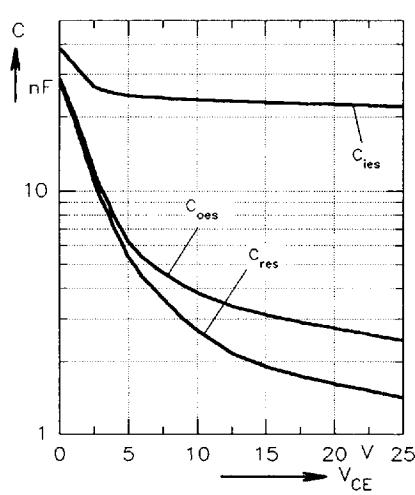


Fig. 8 Typ. capacitances

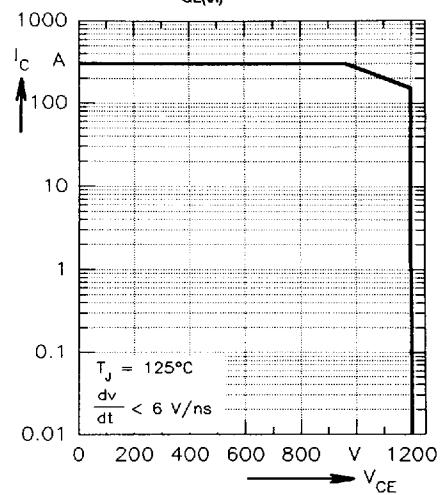


Fig. 9 Reverse biased SOA

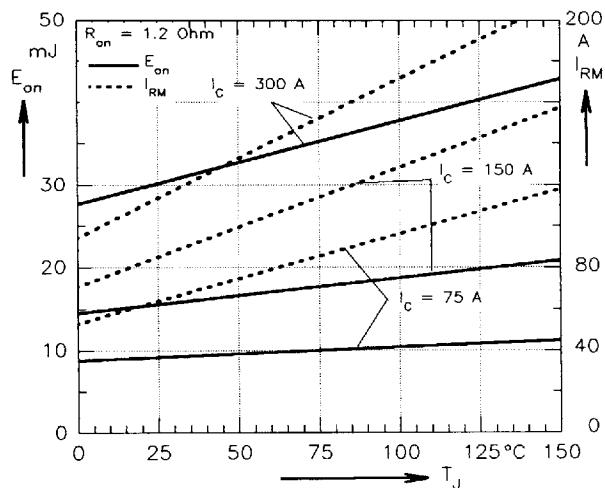


Fig. 10 Typ. turn-on energy per pulse

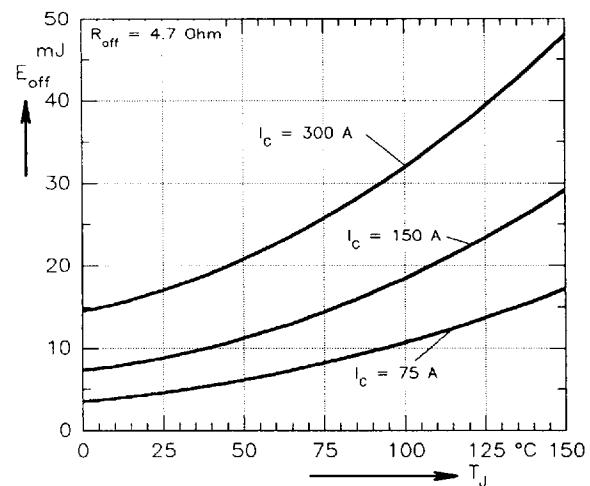


Fig. 11 Typ. turn-off energy per pulse

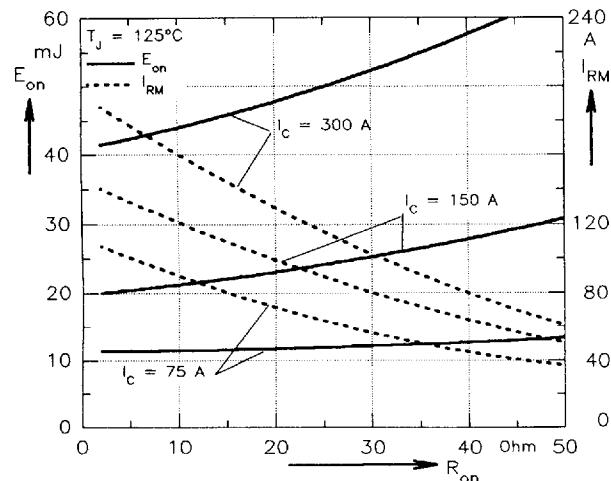


Fig. 12 Typ. turn-on energy per pulse

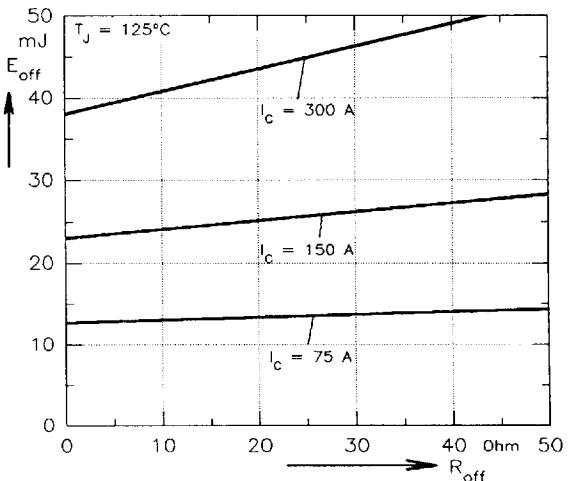


Fig. 13 Typ. turn-off energy per pulse

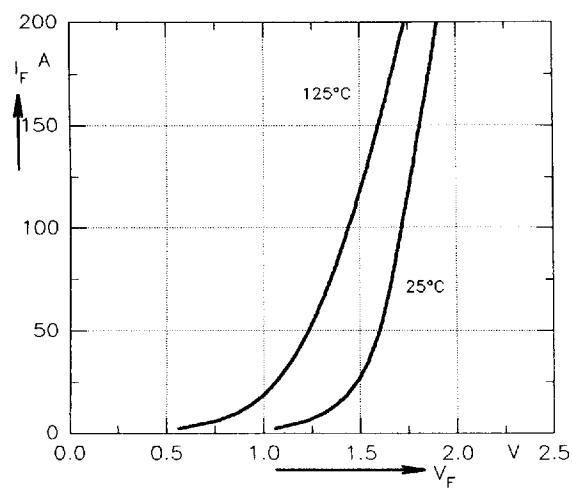


Fig. 14 Typ. forward characteristic of reverse diode

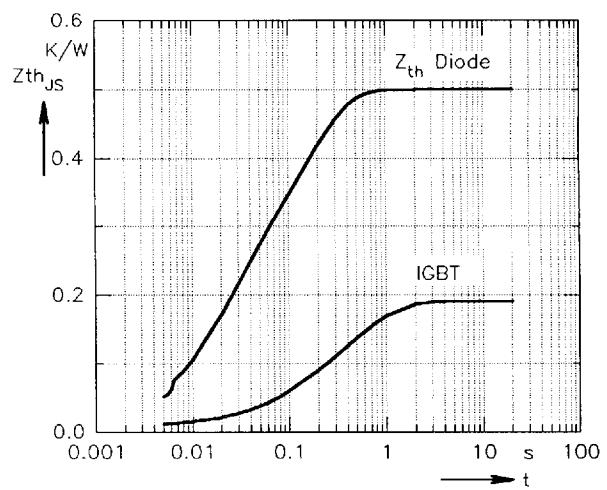


Fig. 15 Transient thermal resistance junction to heatsink of IGBT and Diode (per leg)